

11-25-2005

2003 P 51197 US

RE



103125483

To the Director of the U.S. Patent and Ti

or the new address(es) below.

1. Name of conveying party(ies)

Tiang Hock Lin

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) June 16, 2003

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Joint Research Agreement  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License  
☐ Other

2. Name and address of receiving party(ies)

Name: Infineon Technologies AG

Internal Address:

Street Address: St. Martin Str. 53

City: Munich

State:

Country: Germany Zip: 81669

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No.(s)

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Ira S. Matsil

Slater & Matsil, L.L.P.

Internal Address:

Street Address: 17950 Preston Rd.

Suite 1000

City: Dallas

State: Texas Zip: 75252-5793

Phone Number: 972-732-1001

Fax Number: 972-732-9218

Email Address: matsil@slater-matsil.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card  
☒ Authorized to be charged to deposit account  
☐ Enclosed  
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers  
Expiration Date

b. Deposit Account Number 50-1065

Authorized User Name Ira S. Matsil

9. Signature:

Signature

November 16, 2005

Date

Ira S. Matsil, Reg. No. 35,272

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

11/23/2005 ECOOPER 00000044 501065 1120069

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PATENT  
REEL: 017252 FRAME: 0930

## ASSIGNMENT

WHEREAS, LIN Tiang Hock, a citizen of Malaysia  
of 142, Marsiling Road #08-2098 Singapore 730142  
(hereinafter referred to as 'ASSIGNOR') have invented an improvement in AN  
INTEGRATED CIRCUIT PACKAGE (file FP1910) and have executed a PCT application  
based thereon filed 20 May 2003 under application number PCT/SG03/00120;

AND, WHEREAS, Infineon Technologies AG, a company organized and existing under the  
laws of Germany  
of St.-Martin-Strasse 53 81669 Munich Germany  
(hereinafter referred to as ASSIGNEE) is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one Singapore dollar and other good and valuable consideration,  
receipt of all of which is hereby acknowledged, said ASSIGNOR has agreed to and do hereby  
sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and  
throughout the United States of America (including its territories and dependencies) and all  
countries foreign thereto in and to said invention, said PCT application, any United States  
applications (including provisional, non-provisional, divisional, continuing, or reissue  
applications) based in whole or in part on said PCT application or in whole or in part on said  
invention, any foreign applications based in whole or in part on the aforesaid PCT application  
or in whole or in part on said invention, and any and all patents (including extensions thereof)  
of any country which have been or may be granted on any of the aforesaid applications or on  
said invention or any part thereof;

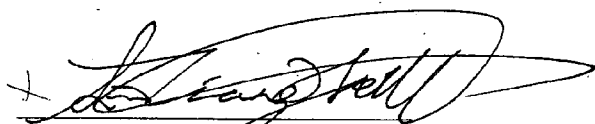
TO BE HELD AND ENJOYED by said ASSIGNEE, its successors and assigns, as fully and  
entirely as the same would have been held and enjoyed by said ASSIGNOR had no sale and  
assignment of said interest been made;


AND said ASSIGNOR hereby authorizes and requests the Commissioner of Patents of the  
United States of America to issue any and all United States patents which may be granted  
upon any United States patent applications based in whole or in part on the aforesaid PCT  
application, or upon said invention or any part thereof, to said ASSIGNEE;

AND said ASSIGNOR agrees for him/herself and for his/her heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

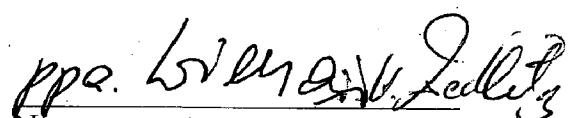
AND said ASSIGNOR hereby covenants for him/herself and his/her legal representatives that no right or license has been granted to make, use or sell said invention, to anyone except said ASSIGNEE, that prior to the execution of this agreement the right, title and interest in said invention had not been otherwise encumbered, and that no instrument will be executed in conflict herewith.

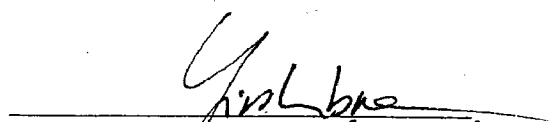
IN WITNESSETH thereof this agreement has been executed by said ASSIGNOR and duly authorized representatives of said ASSIGNEE.

  
Name: LIN Tiang Hock  
Date: 11/6/03

x  16/6/03  
Witness: Chia Tian Nee Cynthia

For and on behalf of Infineon Technologies AG

  
Name: Dr. Willmsau Zedlitz  
Position: Vice President Senior Director Patents & Trademarks  
Date: München, 23.07.2003

  
Witness: Susanne Girstenbrein

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